

Inductors for power circuits
Thin-film metal magnetic material
TMS-ALM series









TMS252012ALM type













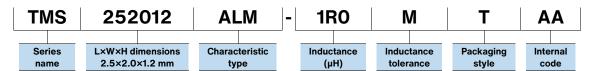
FEATURES

- By using metal magnetic material with high Saturation magnetic flux density the excellent DC bias characteristics needed for inductors for power circuits can be achieved.
- With the same product shape and terminal structure as general chip parts it has excellent mounting stability characteristics and can also be mounted to general-purpose land patterns.
- By using a closed magnetic circuit structure leakage flux is minimized.

APPLICATION

Olndustrial equipment, HDD, SSD, DVC, DSC, smart phones, mobile display panels, portable game devices, compact power supply modules, other

PART NUMBER CONSTRUCTION



CHARACTERISTICS SPECIFICATION TABLE

L		LMeasuring frequency	DC resistar	nce	Rated current*		Rated voltage		Rated voltage	Part No.
(µH)	Tolerance	(MHz)	(mΩ)max.	(mΩ)typ.	Isat (A)max.	(A)typ.	Itemp (A)max.	(A)typ.	(V)max.	
0.047	±30%	1	7	3	12	14	8.0	14	20	TMS252012ALM-47NNTAA
0.10	±20%	1	9	4	10	12	8.0	12	20	TMS252012ALM-R10MTAA
0.15	±20%	1	11	6	9.0	10	7.3	9.8	20	TMS252012ALM-R15MTAA
0.22	±20%	1	13	8	8.0	9.0	6.7	8.5	20	TMS252012ALM-R22MTAA
0.33	±20%	1	18	13	7.0	7.8	5.7	6.6	20	TMS252012ALM-R33MTAA
0.47	±20%	1	24	19	5.8	6.5	4.9	5.6	20	TMS252012ALM-R47MTAA
0.68	±20%	1	34	26	4.8	5.4	4.1	4.7	20	TMS252012ALM-R68MTAA
1.0	±20%	1	42	35	4.2	4.7	3.7	4.1	20	TMS252012ALM-1R0MTAA
1.5	±20%	1	60	52	3.3	3.9	3.1	3.3	20	TMS252012ALM-1R5MTAA
2.2	±20%	1	84	75	2.8	3.3	2.6	2.8	20	TMS252012ALM-2R2MTAA
3.3	±20%	1	140	124	2.1	2.5	2.0	2.2	20	TMS252012ALM-3R3MTAA
4.7	±20%	1	200	180	1.9	2.2	1.6	1.8	20	TMS252012ALM-4R7MTAA

^{*} Rated current: smaller value of either Isat or Itemp.

Isat: When based on the inductance change rate (30% below the nominal value)

Itemp: When based on the temperature increase (temperature increase of 40°C by self heating)

Measurement equipment

Measurement item	Product No. *	Manufacturer
L	4294A	Keysight Technologies
DC resistance	Digital Milliohm Meter	
Rated current Isat	4285A+42841A+42842C	Keysight Technologies

^{*} Equivalent measurement equipment may be used.

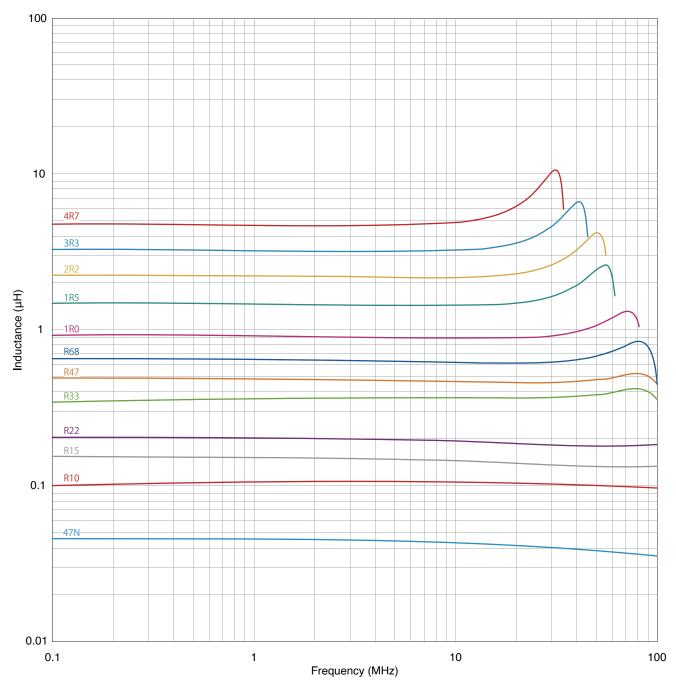


inductor_commercial_power_tms252012alm_en



TMS252012ALM type

L FREQUENCY CHARACTERISTICS



Measurement equipment

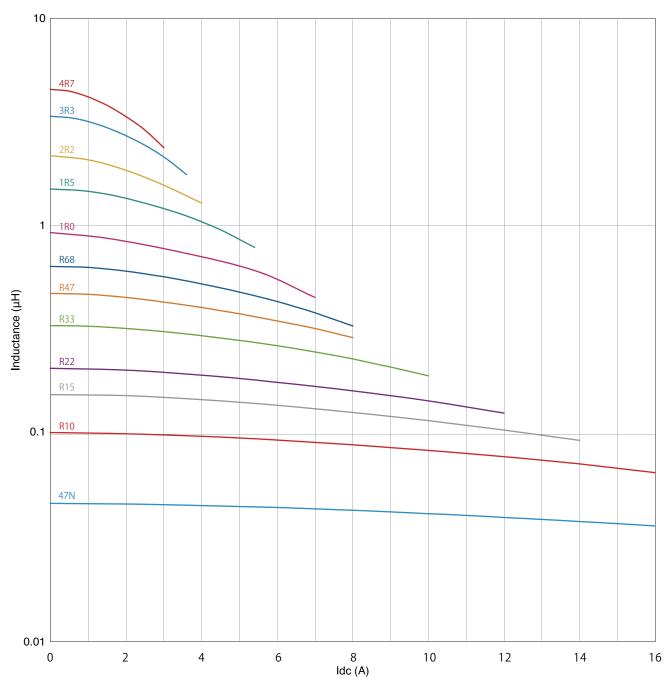
Product No. *	Manufacturer
4294A	Keysight Technologies

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INDUCTANCE VS. DC BIAS CHARACTERISTICS



Measurement equipment

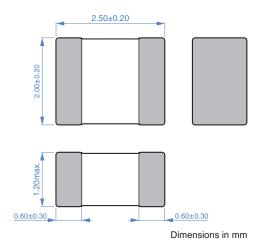
Product No. *	Manufacturer
4285A+42841A+42842C	Keysight Technologies

^{*} Equivalent measurement equipment may be used.

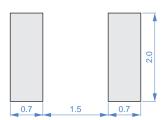


TMS252012ALM type

SHAPE & DIMENSIONS

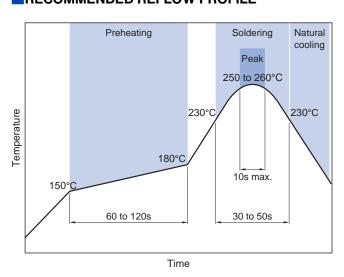


RECOMMENDED LAND PATTERN



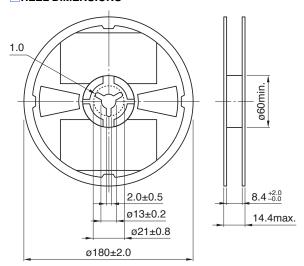
Dimensions in mm

RECOMMENDED REFLOW PROFILE



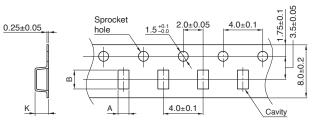
PACKAGING STYLE

REEL DIMENSIONS



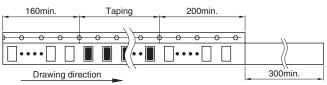
Dimensions in mm

TAPE DIMENSIONS



Dimensions in mm

Туре	Α	В	K
TMS252012ALM	2.3	2.8	1.3



Dimensions in mm

PACKAGE QUANTITY

Package quantity	3000 pcs/reel

TEMPERATURE RANGE, INDIVIDUAL WEIGHT

Operating temperature range *	Storage temperature range **	Individual weight
-40 to +125°C	-40 to +125°C	35 ma

^{*} Operating temperature range includes self-heating.

^{**} The storage temperature range is for after the assembly.

(5) Atomic energy-related equipment

(6) Seabed equipment



REMINDERS FOR USING THESE PRODUCTS

Before using these products, be sure to request the delivery specifications.

SAFETY REMINDERS

Please pay sufficient attention to the warnings for safe designing when using this products

REMINDERS

 The storage period is within 6 months. Be sure to follow the st RH or less). If the storage period elapses, the soldering of the terminal elections. 	
ODo not use or store in locations where there are conditions suc	ch as gas corrosion (salt, acid, alkali, etc.).
Before soldering, be sure to preheat components. The preheating temperature should be set so that the temperatemperature does not exceed 150°C.	ature difference between the solder temperature and chip
Soldering corrections after mounting should be within the rang If overheated, a short circuit, performance deterioration, or life	· · · · · · · · · · · · · · · · · · ·
When embedding a printed circuit board where a chip is moun due to the overall distortion of the printed circuit board and pa	·
Self heating (temperature increase) occurs when the power is thermal design.	turned ON, so the tolerance should be sufficient for the set
Carefully lay out the coil for the circuit board design of the nor A malfunction may occur due to magnetic interference.	n-magnetic shield type.
Use a wrist band to discharge static electricity in your body the	rough the grounding wire.
On not expose the products to magnets or magnetic fields.	
ODo not use for a purpose outside of the contents regulated in t	the delivery specifications.
or quality require a more stringent level of safety or reliability, damage to society, person or property.	er equipment, personal equipment, office equipment, eration and use condition. ements of the applications listed below, whose performance and
 (1) Aerospace/aviation equipment (2) Transportation equipment (cars, electric trains, ships, etc.) (3) Medical equipment (4) Power-generation control equipment 	(7) Transportation control equipment(8) Public information-processing equipment(9) Military equipment(10) Electric heating apparatus, burning equipment

When designing your equipment even for general-purpose applications, you are kindly requested to take into consideration securing protection circuit/device or providing backup circuits in your equipment.

(11) Disaster prevention/crime prevention equipment

(13) Other applications that are not considered general-purpose

(12) Safety equipment

applications